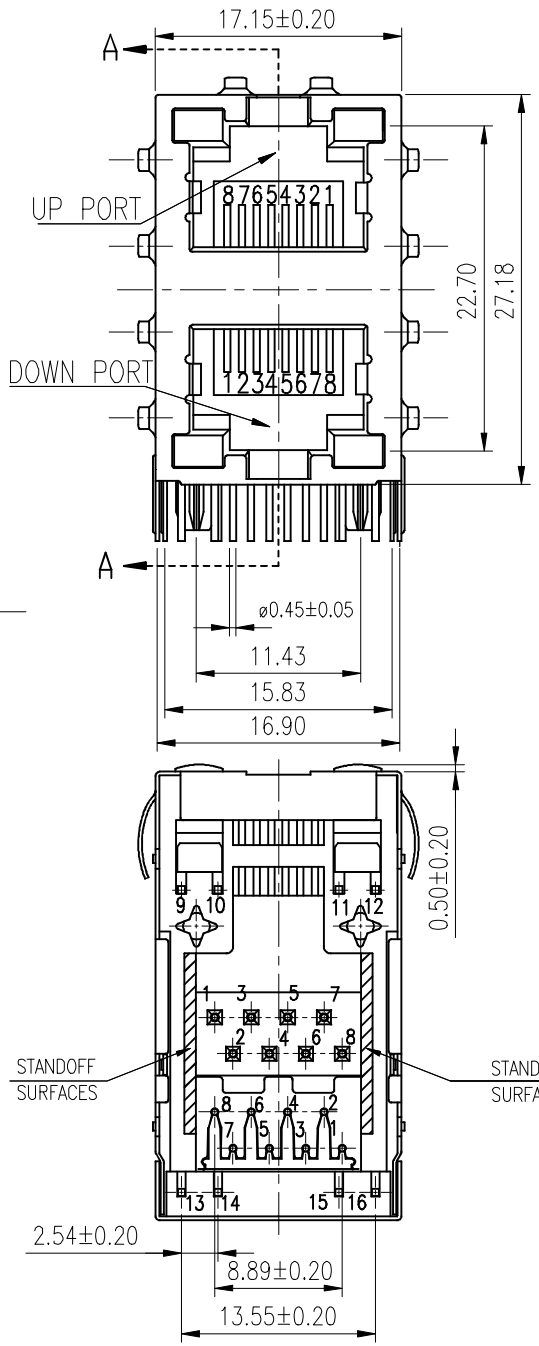
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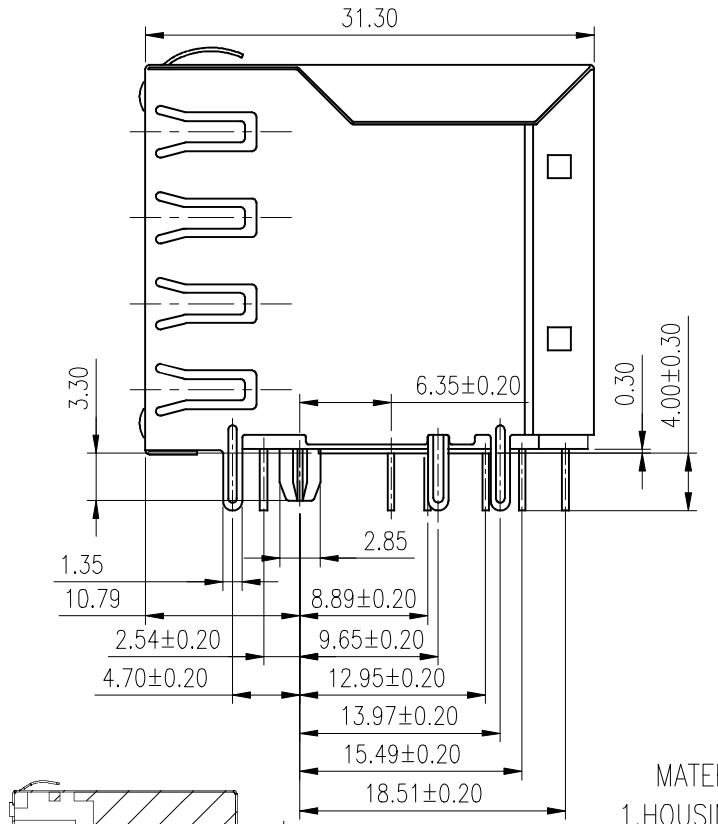
The marking on thisproduct doesn't contain environmental hazardous materials per Material Specification SS-00259 for Sony GP compliant or per directive 2011/65/EU for RoHS compliant.

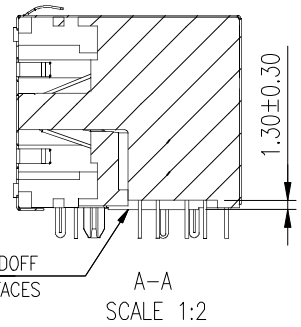
CUSTOMER DRAWING

REVISIONS				
SYM	ECN No.	DESCRIPTION	DATE	APPROVED
A	NE-16168	FORMAL RELEASE	07/07/2016	Roger Tsai
BX1	/	ADD Standoff Height size and Material thickness	08/21/2017	Roger Tsai
BX2		Increase location column size	09/13/2017	Roger Tsai

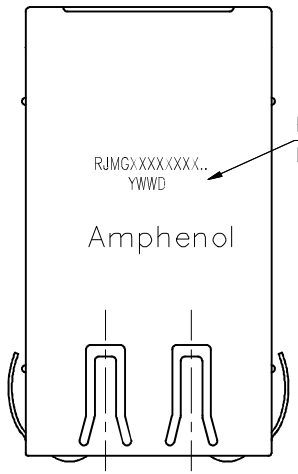
ORIGINAL







A–A
SCALE 1:2



TOP VIEW

MATERIALS:

1. HOUSING:GLASS FILLED PA6T BLACK (ROHS).
2. INSERT:GLASS FILLED PA6T BLACK (ROHS).
3. SHIELDING: C2680,THICKNESS=0.20mm,NICKEL 50u"Min. PLATED(ROHS).
4. CONTACT: PHOSPHOR BRONZE ø0.45mm,GOLD FLASH PLATING OVER NICKEL 50u"Min.(ROHS).
5. WAVE SOLDERING TEMPERATURE: 260°C FOR 10 SECONDS MAX
   IR REFLOW TEMPERATURE: 245°C FOR 10 SECONDS MAX

TOLERANCE	APPROVALS	DATE
X.	DRAWN Arvin Ye	08/21/2017
X.X ±0.35	CHECKED Vivian Wen	08/21/2017
X.XX ±0.25	APPROVED Roger Tsai	08/21/2017
X.XXX ±0.15	DWG TYPE CUST DWG	PROJECT CODE RJMG
ANGULAR ±1°		
UNLESS OTHERWISE SPECIFIED		

TITLE: RJ45 2X1 without Magnetic 2x1 WITH LED Option for PIP/PIH process

UNIT: mm | SIZE: A3 | SCALE: NA | SHEET: 1 OF 3

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Amphenol Taiwan Corporation

PART No. RJMG021021105CR
DWG No. RJMG021021105CR
REV. BX2

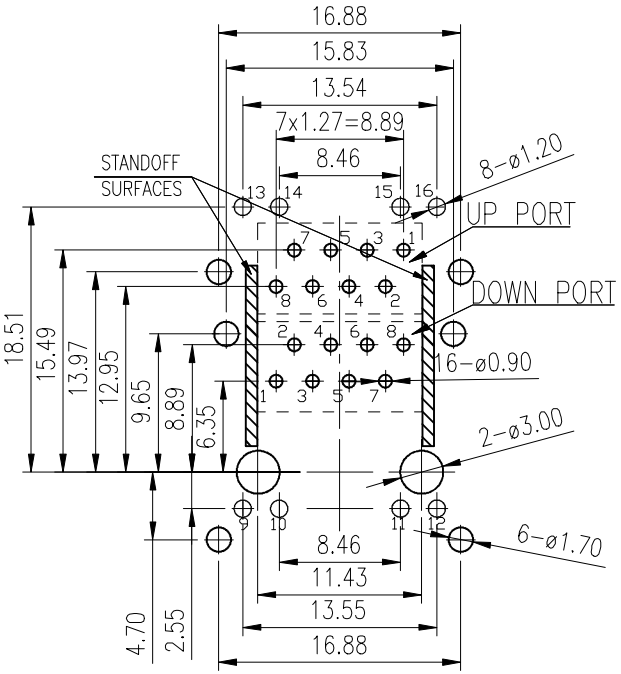
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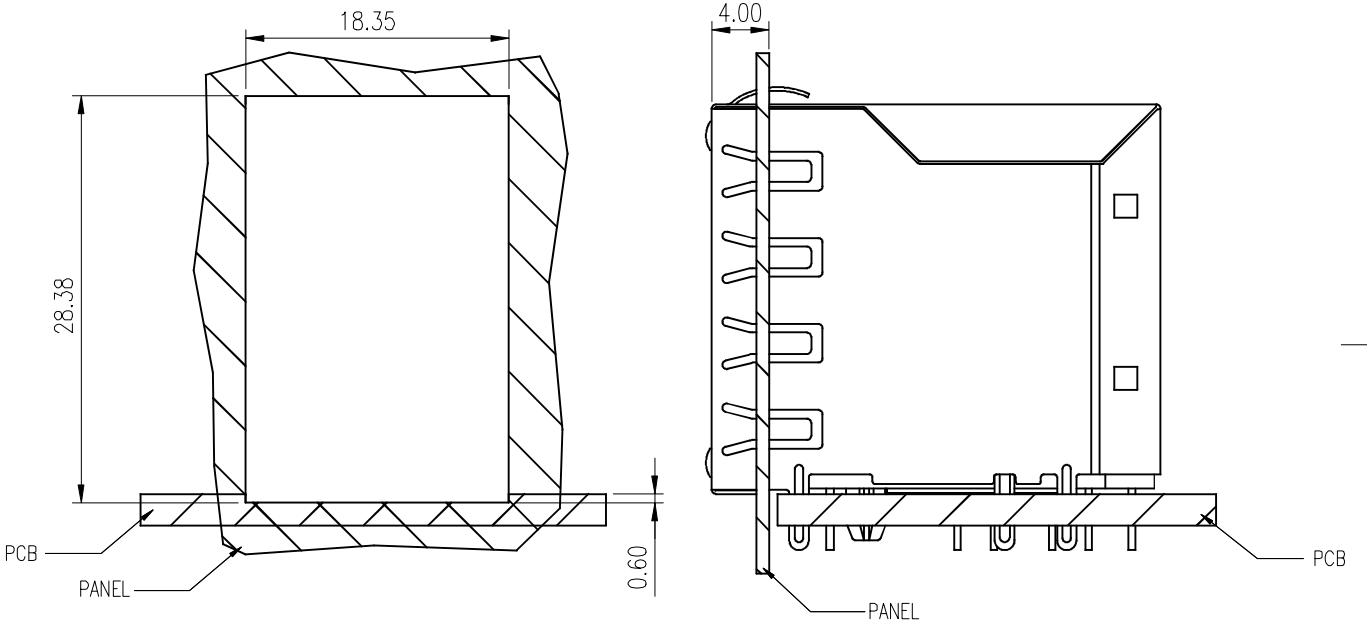
CUSTOMER DRAWING

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ORIGINAL

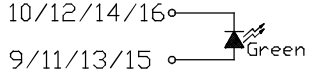


RECOMMENDED PCB LAYOUT COMPONENT SIDE
ALL DIMENSION TOLERANCE ARE ±0.08 UNLESS OTHERWISE SPECIFIED



RECOMMENDED PANEL CUTOUT

LED SPECIFICATION



TOLERANCE	APPROVALS	DATE
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X.X ±0.35	CHECKED Vivian Wen	08/21/2017
X.XX ±0.25	APPROVED Roger Tsai	08/21/2017
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UNIT: mm | SIZE: A3 | SCALE: NA | SHEET: 2 OF 3

PART No.: RJMG021021105CR

DWG No.: RJMG021021105CR | REV.: BX2

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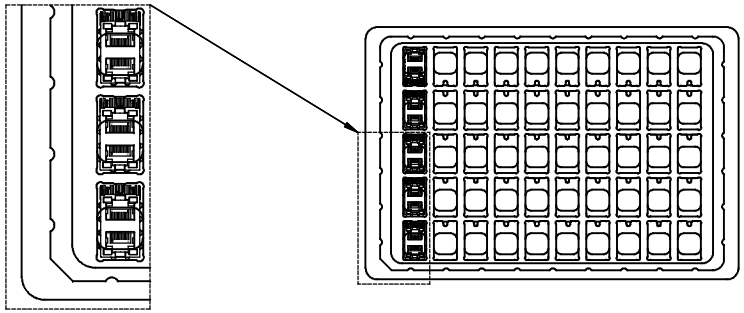
Amphenol Taiwan RoHS Compliant 2011/65/EU

CUSTOMER DRAWING

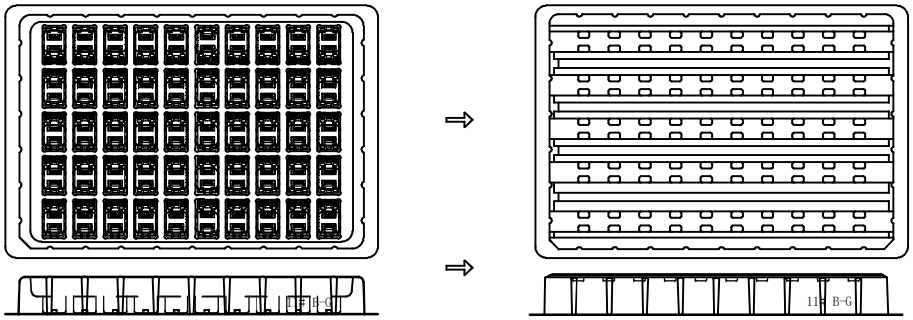
ORIGINAL

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1.On the right way to Put the product into the tray,per tray take 50PCS(show as the following picture)

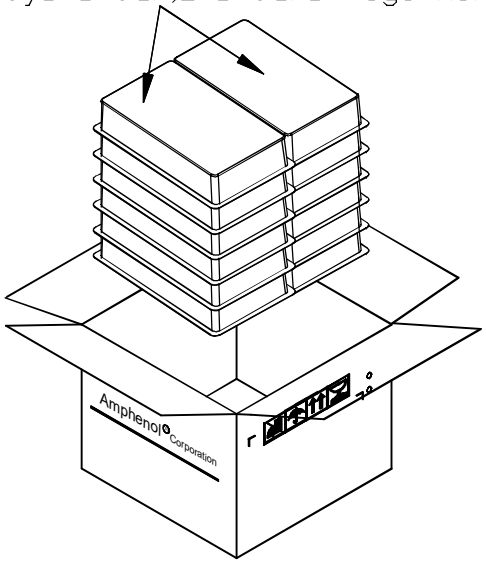


2.After the tray full filled the products,put cover above tray and then paste label on the cover (show as following picture)

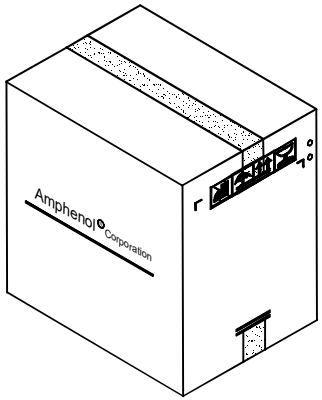


3.Put 6 trays products together as a stack,and then put 2 stacks into a carton box (Show as following picture)

(6Trays/stack,2 stacks together)



4.Sealing the carton box with tape and paste label on it



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PRODUCT P/N	PCS PER TRAY	TRAYS PER BOX	PCS PER BOX
RJMG021021105CR	50	12	600

TOLERANCE	APPROVALS	DATE	TITLE
X.	DRAWN Arvin Ye	08/21/2017	RJ45 2X1 without Magnetic 2x1 WITH LED Option for PIP/PIH process
X.X ±0.35 X.XX ±0.25 X.XXX ±0.15	CHECKED Vivian Wen	08/21/2017	
ANGULAR ±1°	APPROVED Roger Tsai	08/21/2017	
UNLESS OTHERWISE SPECIFIED	DWG TYPE CUST DWG	PROJECT CODE RJMG	

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UNIT	SIZE	PART No.	
mm	A3	RJMG021021105CR	
SCALE	SHEET	DWG No.	REV.
NA	3 OF 3	RJMG021021105CR	BX2